



Docket No.: M4065.0127/P127-A
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Kie Y. Ahn, et al.

Application No.: 09/660,324

Group Art Unit: 2823

Filed: September 12, 2000

Examiner: E. Toledo

For: SILICON MULTI-CHIP MODULE
PACKAGING WITH INTEGRATED
PASSIVE COMPONENTS AND METHOD
OF MAKING

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STATEMENT OF COMMON OWNERSHIP

Commissioner for Patents
Washington, DC 20231

Dear Sir:

The present Application, numbered 09/660,324, and U.S. Patent No. 6,201,287 B1 (Forbes) describe and claim subject matter which, at the time the invention of Application 09/660,324 was made, was commonly owned by Micron Technology Inc., Boise ID.

Dated: October 26, 2001

Respectfully submitted,

By 
Thomas J. D'Amico

Registration No.: 28,371
DICKSTEIN SHAPIRO MORIN &
OSHINSKY LLP
2101 L Street NW
Washington, DC 20037-1526
(202) 828-2232
Attorneys for Applicant



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2823
PTO/SB/21 (08-00)

Approved for use through 10/31/2002. OMB 0651-0031
U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

TRANSMITTAL FORM

(to be used for all correspondence after initial filing)

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| | | Application Number | 09/660,324 |
| | | Filing Date | September 12, 2000 |
| | | First Named Inventor | Kie Y. Ahn |
| | | Group Art Unit | 2823 |
| | | Examiner Name | F. Toledo |
| Total Number of Pages in This Submission | | Attorney Docket Number | M4065.0127/P127-A |

ENCLOSURES (check all that apply)

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| <input checked="" type="checkbox"/> Amendment/Reply | <input type="checkbox"/> Licensing-related Papers | <input type="checkbox"/> Appeal Communication to Group (Appeal Notice, Brief, Reply Brief) |
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| Firm or Individual Name | DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP Thomas J. D'Amico |
| Signature | |
| Date | October 26, 2001 |

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